

# PC450T11

## Photocoupler with Built-in Breakdown Diode for Surge Voltage Absorption

### Features

1. Built-in breakdown diode for absorption of surge voltage
2. High current transfer ratio (CTR : MIN. 2 000% at  $I_F=5\text{mA}$ )
3. Mini-flat package
4. Applicable to soldering reflow
5. Available tape packaged products

### Applications

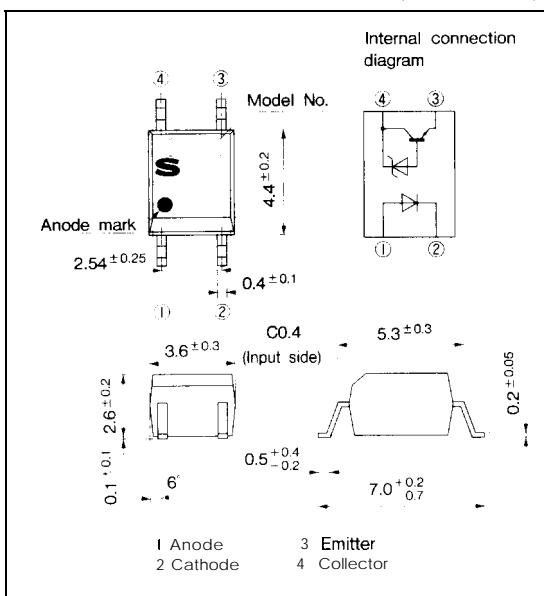
1. Programmable controllers

### Package Specifications

Model No.	Package Specification
PC450T11	Taping diameter 178mm(750pcs.)

### Outline Dimensions

(Unit : mm)



### Absolute Maximum Ratings

(Ta = 25°C)

Parameter	Symbol	Rating	Unit
Input	Forward current	IF	mA
	* <sup>1</sup> Peak forward current	I <sub>FM</sub>	A
	Reverse voltage	V <sub>R</sub>	V
	Power dissipation	P	mW
output	Emitter -collector voltage	v <sub>ECO</sub>	V
	* <sup>2</sup> Surge endurance	E <sub>sj</sub>	mJ
	Collector current	I <sub>C</sub>	mA
	Collector power dissipation	P <sub>C</sub>	mW
	Total power dissipation	P <sub>tot</sub>	mW
	*{Isolation voltage	V <sub>iso</sub>	kV <sub>rms</sub>
Operating temperature	T <sub>opr</sub>	-30 to +100	°C
Storage temperature	T <sub>stg</sub>	-40 to +125	°C
*Soldering temperature	T <sub>sot</sub>	260	°C

\*1 Pulse width  $\leq 100 \mu\text{s}$ , Duty ratio :0.001\*2 E<sub>sj</sub> = 40V(V<sub>CEO</sub>) $\times$ 100mA(I<sub>C</sub>) $\times$ 10ms $\times$ 1/2

\*3 AC for 1 min., 40 to 60%RH, f = 60Hz

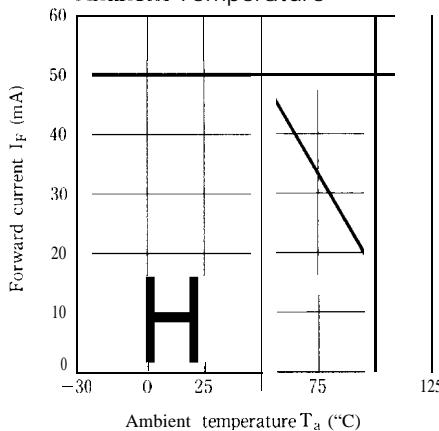
\*4 For 10 seconds

**■ Electro-optical Characteristics**

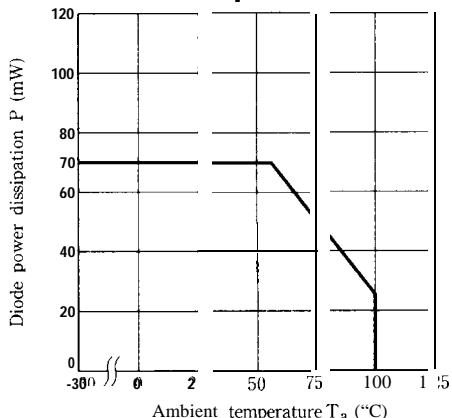
(Ta=25°C)

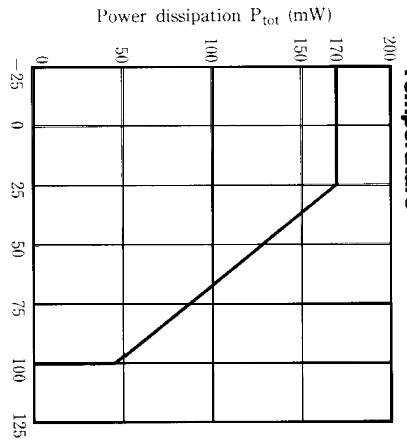
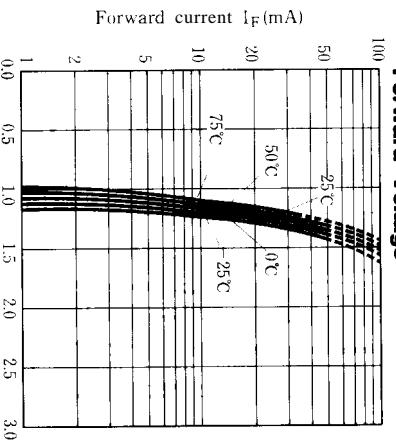
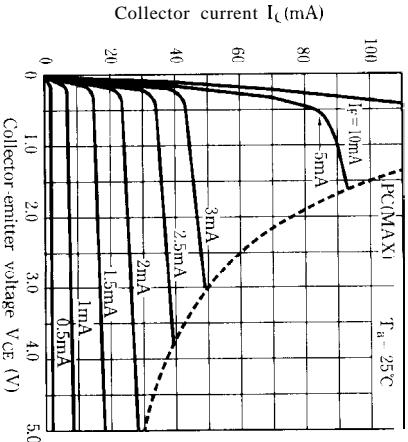
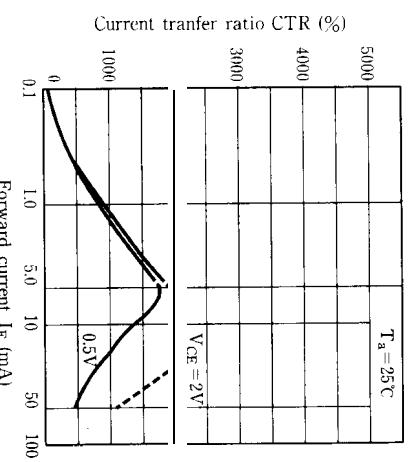
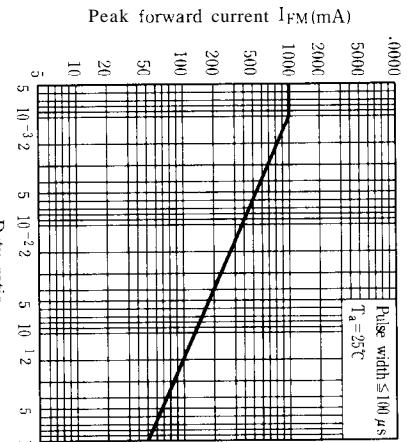
Parameter		Symbol	Conditions	MIN.	TYP.	MAX	Unit
Input	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =20mA		1.2	1.4	V
	Reverse current	I <sub>R</sub>	V <sub>R</sub> =4V			10	μA
	Terminal capacitance	C <sub>t</sub>	V=0, f=1kHz	—	30	250	pF
output	Collector dark current	I <sub>CEO</sub>	V <sub>CE</sub> =20V, I <sub>F</sub> =0			5	μA
	Collector -emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>F</sub> =0, I <sub>C</sub> =0.1mA	40		60	V
	Emitter-collector breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> =10 μA, I <sub>F</sub> =0	6	—	—	V
	Collector current	I <sub>C</sub>	V <sub>CE</sub> =2V, I <sub>F</sub> =5mA	75	—	—	mA
Transfer characteristics	Collector -emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>F</sub> =10mA I <sub>C</sub> =100mA	—	—	0,5	V
	Isolation resistance	R <sub>ISO</sub>	DC500V, 40 to 60%RH	5 x 10 <sup>10</sup>	10 <sup>11</sup>	—	Ω
	Floating capacitance	c <sub>f</sub>	V=0, f=1MHz		0.6	1.0	pF
	Response time	Rise time t <sub>r</sub>	V <sub>CE</sub> =2V, I <sub>C</sub> =2mA		50	—	μs
		Fall time t <sub>f</sub>	R <sub>L</sub> =100Ω	—	30	—	μs

**Fig. 1 Forward Current vs.  
Ambient Temperature**

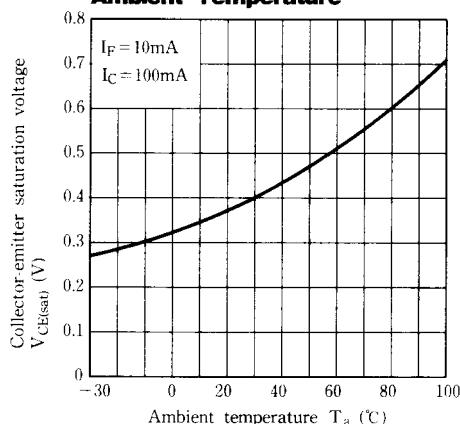


**Fig. 2 Diode Power Dissipation vs.  
Ambient Temperature**

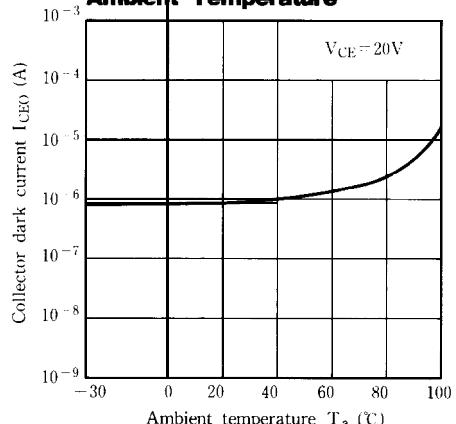


**Fig. 3 Power Dissipation vs. Ambient Temperature****Fig. 5 Forward Current vs. Forward Voltage****Fig. 7 Collector Current vs. Collector-emitter Voltage****Fig. 8 Relative Current Transfer Ratio vs. Ambient Temperature****Fig. 6 Current Transfer Ratio vs. Forward Current**

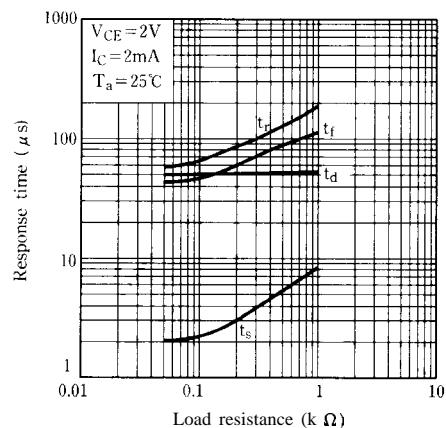
**Fig.9 Collector-emitter Saturation Voltage vs. Ambient Temperature**



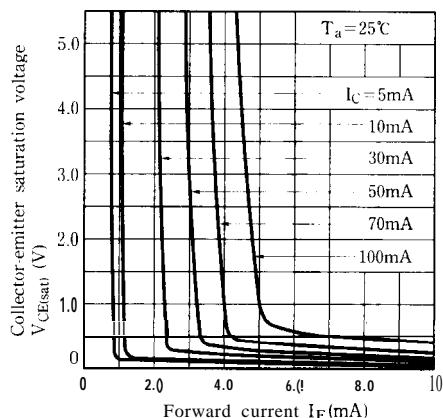
**Fig.10 Collector Dark Current vs. Ambient Temperature**



**Fig.11 Response Time vs. Load Resistance**



**Fig.12 Collector-emitter Saturation Voltage vs. Forward Current**



- Please refer to the chapter "Precautions for Use." (Page 78 to 93)